



TM15G06NF

N+P-Channel Enhancement Mode Mosfet

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|--|--|
| <p>General Description</p> <ul style="list-style-type: none"> • Low $R_{DS(ON)}$ • RoHS and Halogen-Free Compliant <p>Applications</p> <ul style="list-style-type: none"> • Load switch • PWM | <p>General Features</p> <p>N Channel $V_{DS} = 60V, I_D = 17A$ $R_{DS(ON)} = 24m\Omega @ V_{GS} = 10V$</p> <p>P Channel $V_{DS} = -60V, I_D = -13A$ $R_{DS(ON)} = 68m\Omega @ V_{GS} = -10V$</p> <p>100% UIS Tested 100% R_g Tested</p> |
|--|--|



NF:DFN5x6-8L

Marking: 15G06

Absolute Maximum Ratings ($T_A = 25^\circ C$ Unless Otherwise Noted)

| Symbol | Parameter | N-Channel | P-Channel | Units |
|----------------|--|-------------|-----------|-------|
| V_{DS} | Drain-Source Voltage | 60 | -60 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | ± 20 | V |
| I_D | Continuous Drain Current-TC=25°C | 17 | -13 | A |
| | Continuous Drain Current-TC=100°C | 12 | -9 | |
| | Pulsed Drain Current | 63 | -48 | |
| P_D | Power Dissipation | 22 | 20 | W |
| T_J, T_{STG} | Operating and Storage Junction Temperature Range | -55 to +150 | | °C |

Thermal Characteristics:

| Symbol | Parameter | Max | Units |
|-----------------|---|-----|-------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case ² | 7 | °C/W |



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N-CH Electrical Characteristics: ($T_C=25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|--|--|---|-----|------|-----------|------------|
| Off Characteristics | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS}=0V, I_D=250 \mu A$ | 60 | --- | --- | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{GS}=0V, V_{DS}=60V$ | --- | --- | 1 | μA |
| I_{GSS} | Gate-Source Leakage Current | $V_{GS}=\pm 20V, V_{DS}=0A$ | --- | --- | ± 100 | nA |
| On Characteristics ^(Note 3) | | | | | | |
| $V_{GS(th)}$ | GATE-Source Threshold Voltage | $V_{GS}=V_{DS}, I_D=250 \mu A$ | 1 | 1.5 | 3 | V |
| $R_{DS(on)}$ | Drain-Source On Resistance | $V_{GS}=10V, I_D=10A$ | --- | 24 | 30 | m Ω |
| | | $V_{GS}=4.5V, I_D=5A$ | --- | 29 | 40 | |
| Dynamic Characteristics ^(Note 4) | | | | | | |
| C_{iss} | Input Capacitance | $V_{DS}=25V, V_{GS}=0V, f=1MHz$ | --- | 1100 | --- | pF |
| C_{oss} | Output Capacitance | | --- | 52 | --- | |
| C_{rss} | Reverse Transfer Capacitance | | --- | 45 | --- | |
| Switching Characteristics ^(Note 4) | | | | | | |
| $t_{d(on)}$ | Turn-On Delay Time | $V_{DD}=30V, R_{GEN}=1.8 \Omega$ $I_D=15A, V_{GS}=10V$ | --- | 7.6 | --- | ns |
| t_r | Rise Time | | --- | 20 | --- | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | --- | 15 | --- | ns |
| t_f | Fall Time | | --- | 24 | --- | ns |
| Q_g | Total Gate Charge | $V_{GS}=10V, V_{DS}=30V,$ $I_D=10A$ | --- | 20.3 | --- | nC |
| Q_{gs} | Gate-Source Charge | | --- | 3.7 | --- | nC |
| Q_{gd} | Gate-Drain "Miller" Charge | | --- | 5.3 | --- | nC |
| Drain-Source Diode Characteristics | | | | | | |
| V_{SD} | Drain Diode Forward Voltage | $V_{GS}=0V, I_S=20A$ | --- | --- | 1.2 | V |
| I_S | Maximum Continuous Drain to Source Diode Forward Current | | --- | --- | 17 | A |
| I_{SM} | Maximum Pulsed Drain to Source Diode Forward Current | | --- | --- | 63 | A |
| T_{rr} | Reverse Recovery Time | $I_F=10A, di/dt=100A/\mu s$ | --- | 29 | --- | Ns |
| Q_{rr} | Reverse Recovery Charge | | --- | 43 | --- | nc |

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Typical Characteristics: ($T_c=25^\circ\text{C}$ unless otherwise noted)

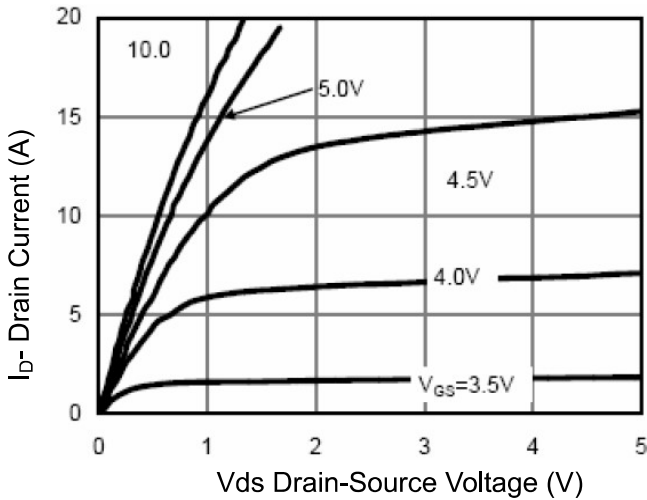


Figure 1 Output Characteristics

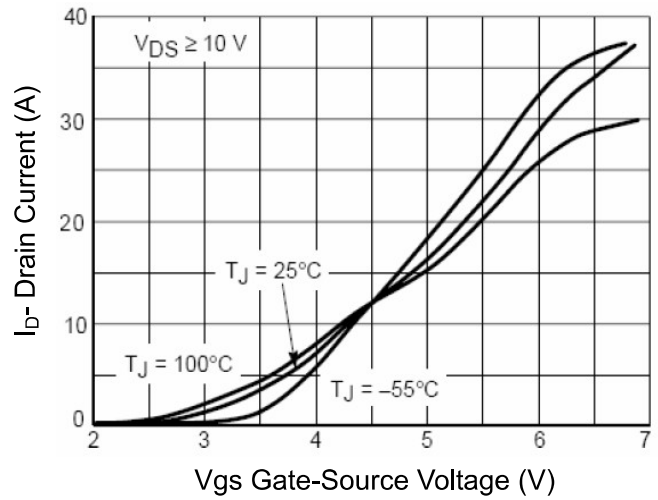


Figure 2 Transfer Characteristics

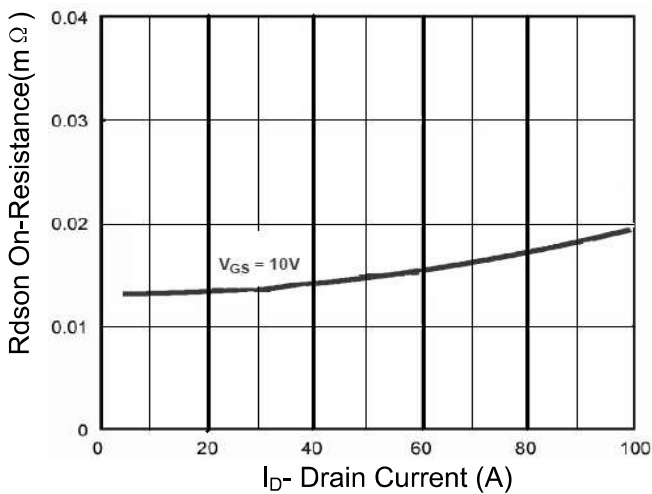


Figure 3 Rdson- Drain Current

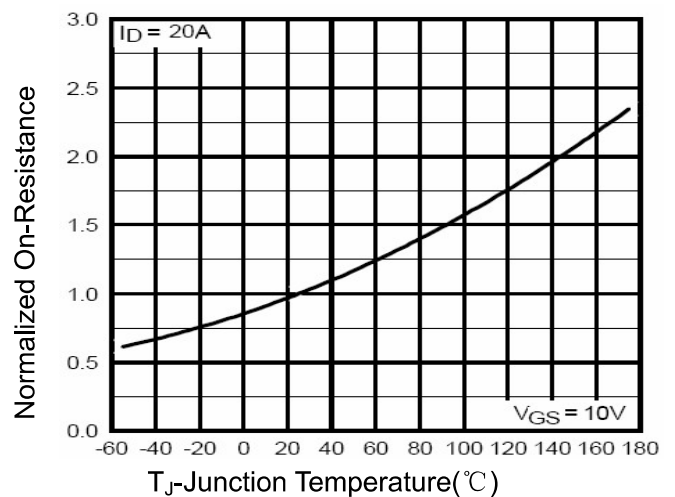


Figure 4 Rdson-Junction Temperature

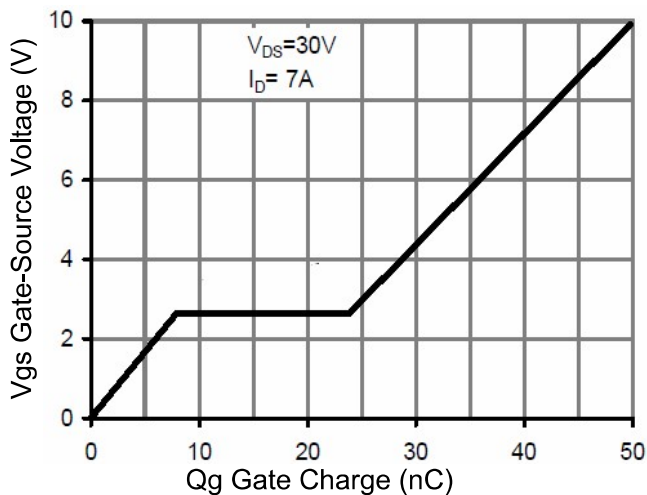


Figure 5 Gate Charge

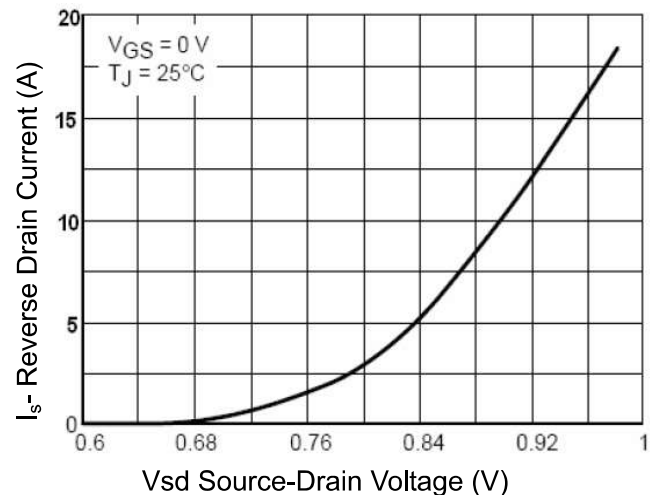


Figure 6 Source- Drain Diode Forward



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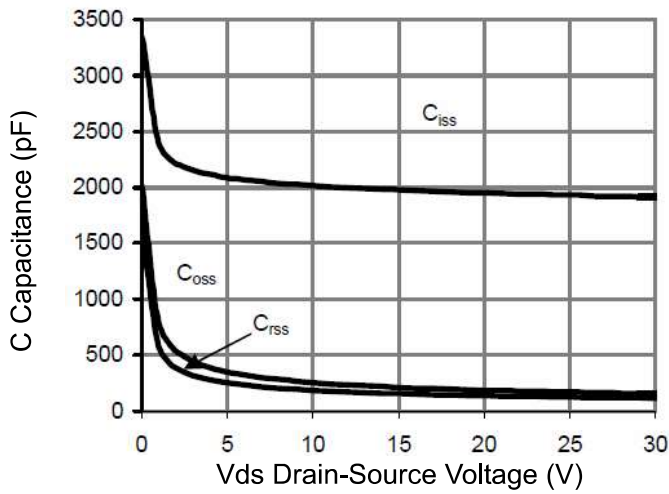


Figure 7 Capacitance vs Vds

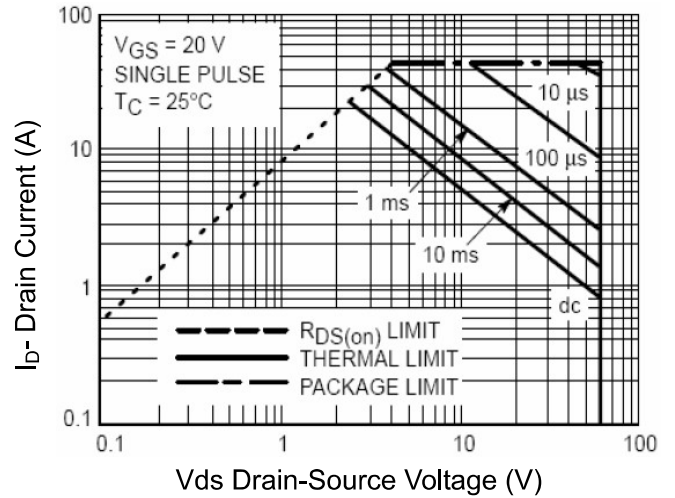


Figure 8 Safe Operation Area

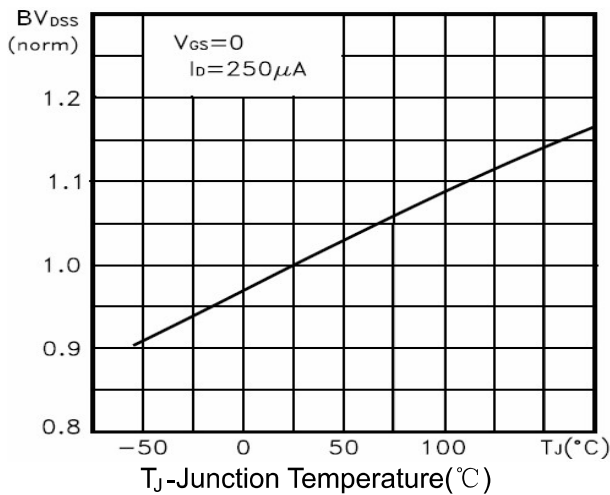


Figure 9 BV vs Junction Temperature

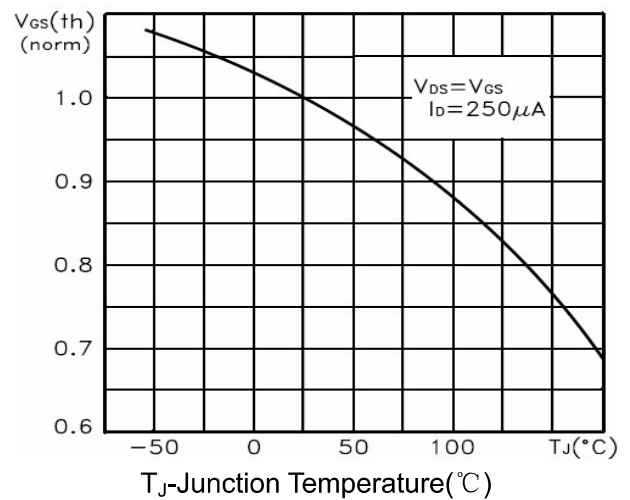


Figure 10 V_{GS(th)} vs Junction Temperature

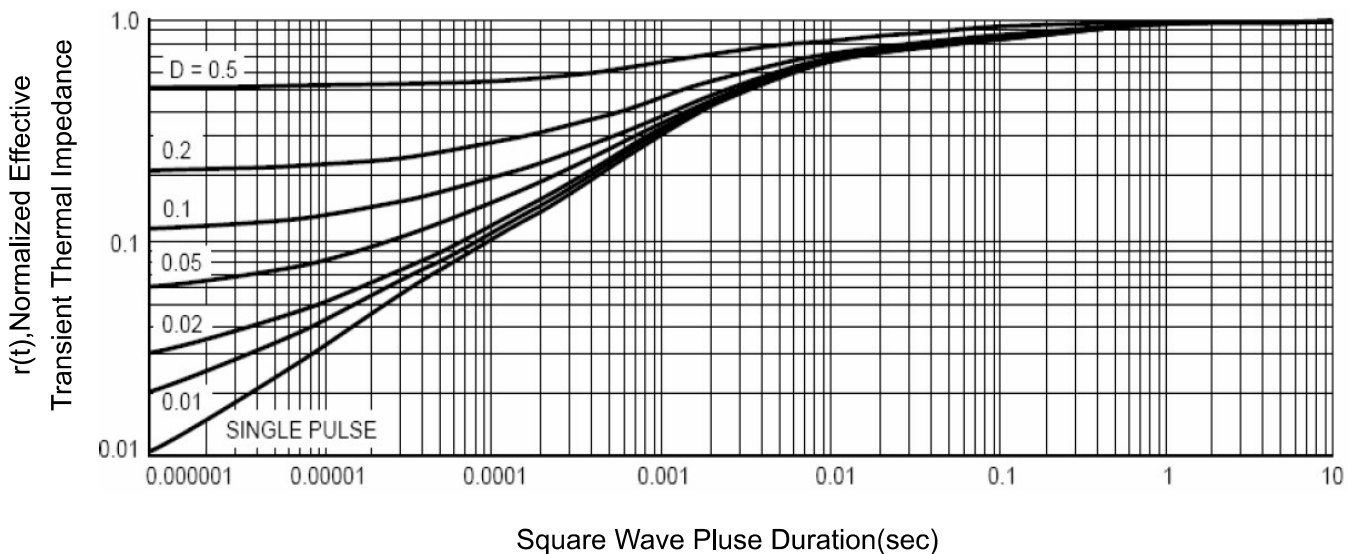


Figure 11 Normalized Maximum Transient Thermal Impedance

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P-CH Electrical Characteristics: ($T_C=25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|--|--|--|-----|------|-----------|------------|
| Off Characteristics | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS}=0V, I_D=250 \mu A$ | -60 | --- | --- | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{GS}=0V, V_{DS}=-60V$ | --- | --- | -1 | μA |
| I_{GSS} | Gate-Source Leakage Current | $V_{GS}=\pm 20V, V_{DS}=0A$ | --- | --- | ± 100 | nA |
| On Characteristics³ | | | | | | |
| $V_{GS(th)}$ | GATE-Source Threshold Voltage | $V_{GS}=V_{DS}, I_D=250 \mu A$ | -1 | -1.5 | -2.2 | V |
| $R_{DS(on)}$ | Drain-Source On Resistance | $V_{GS}=-10V, I_D=-12A$ | --- | 68 | 76 | m Ω |
| | | $V_{GS}=-4.5V, I_D=-8A$ | --- | 77 | 90 | |
| G_{FS} | Forward Transconductance | $V_{DS}=-5V, I_D=-2A$ | --- | 10 | --- | S |
| Dynamic Characteristics⁴ | | | | | | |
| C_{iss} | Input Capacitance | $V_{DS}=-30V, V_{GS}=0V, f=1MHz$ | --- | 1600 | --- | pF |
| C_{oss} | Output Capacitance | | --- | 90 | --- | |
| C_{rss} | Reverse Transfer Capacitance | | --- | 75 | --- | |
| Switching Characteristics⁴ | | | | | | |
| $t_{d(on)}$ | Turn-On Delay Time | $V_{DS}=-30V, R_{GEN}=3 \Omega, V_{GS}=-10V$ | --- | 11 | --- | ns |
| t_r | Rise Time | | --- | 14 | --- | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | --- | 33 | --- | ns |
| t_f | Fall Time | | --- | 13 | --- | ns |
| Q_g | Total Gate Charge | $V_{GS}=-10V, V_{DS}=-30V, I_D=-12A$ | --- | 37.6 | --- | nC |
| Q_{gs} | Gate-Source Charge | | --- | 4.3 | --- | nC |
| Q_{gd} | Gate-Drain Charge | | --- | 7.2 | --- | nC |
| Drain-Source Diode Characteristics | | | | | | |
| V_{SD} | Drain Diode Forward Voltage ³ | $V_{GS}=0V, I_S=-12A, T_J=25^\circ\text{C}$ | --- | --- | -1.2 | V |
| I_S | Continuous Source Current ² | --- | --- | --- | -13 | A |
| T_{rr} | Reverse Recovery Time | $T_J=25^\circ\text{C}, I_F=-12A$ | --- | -35 | --- | ns |
| Q_{rr} | Reverse Recovery Charge | $di/dt = -100A/\mu s$ (Note3) | --- | -38 | --- | nC |

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production
5. E_{AS} condition: $T_J=25^\circ\text{C}, V_{DD}=-20V, V_G=-10V, L=1mH, R_g=25\Omega$



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Typical Characteristics: ($T_C=25^\circ\text{C}$ unless otherwise noted)

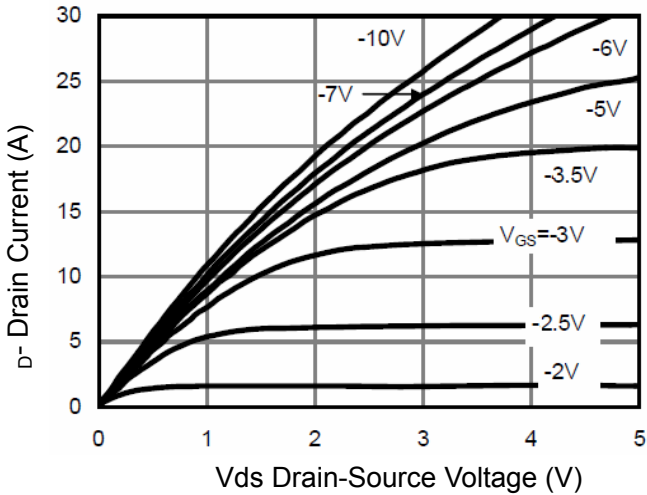


Figure 1 Output Characteristics

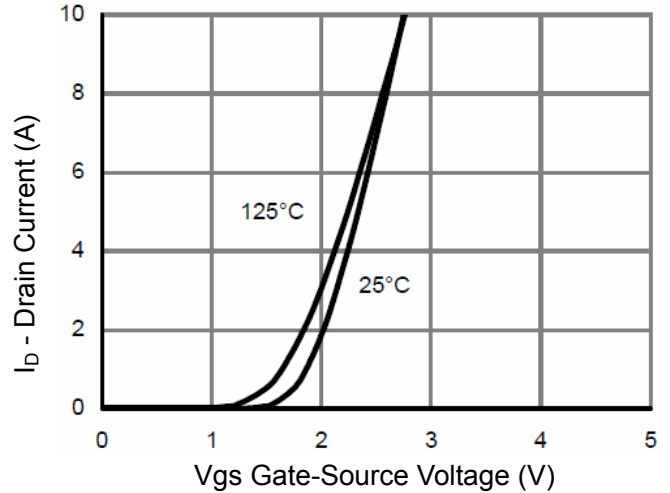


Figure 2 Transfer Characteristics

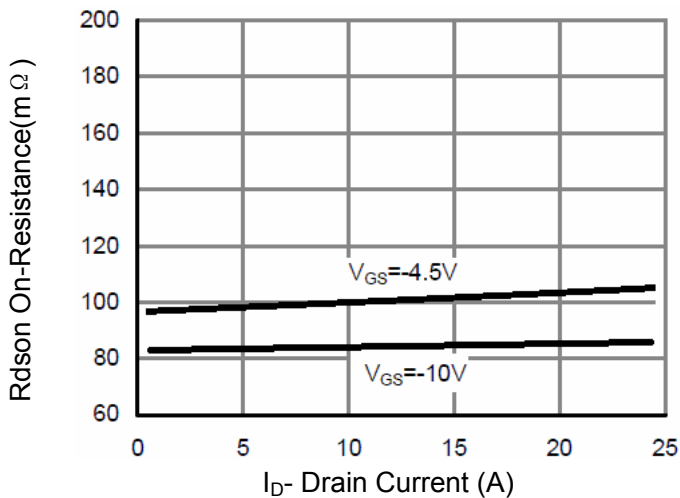


Figure 3 Rdson- Drain Current

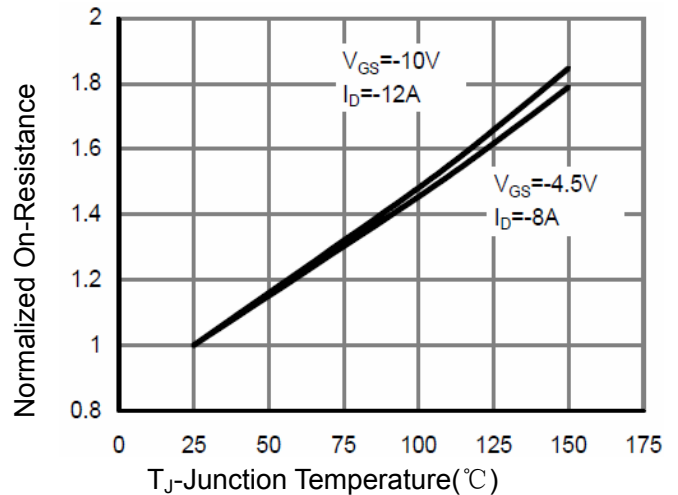


Figure 4 Rdson-Junction Temperature

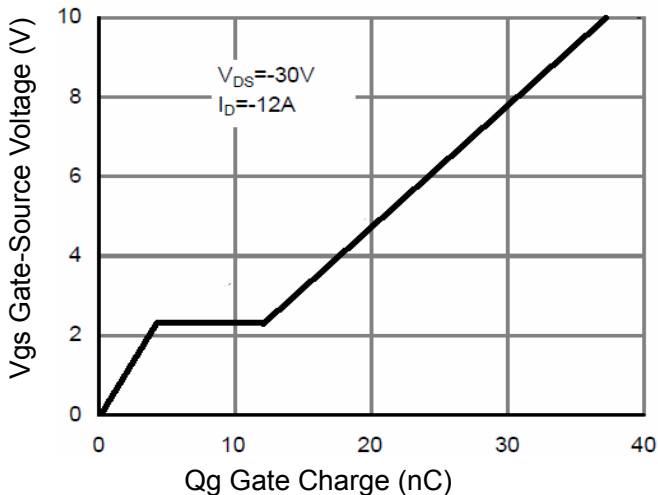


Figure 5 Gate Charge

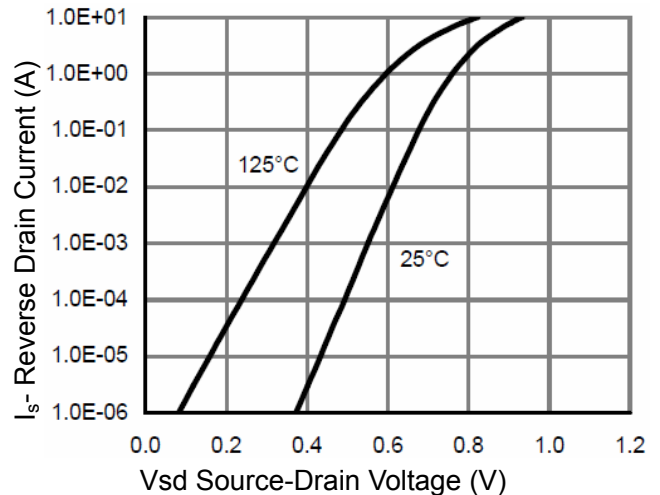


Figure 6 Source- Drain Diode Forward



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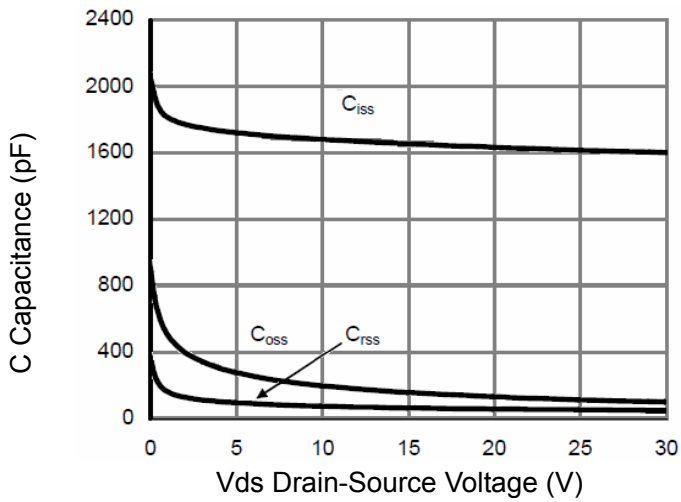


Figure 7 Capacitance vs Vds

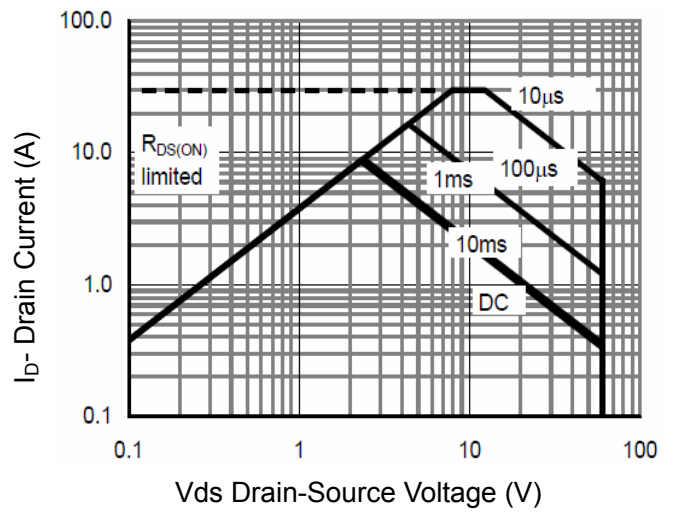


Figure 8 Safe Operation Area

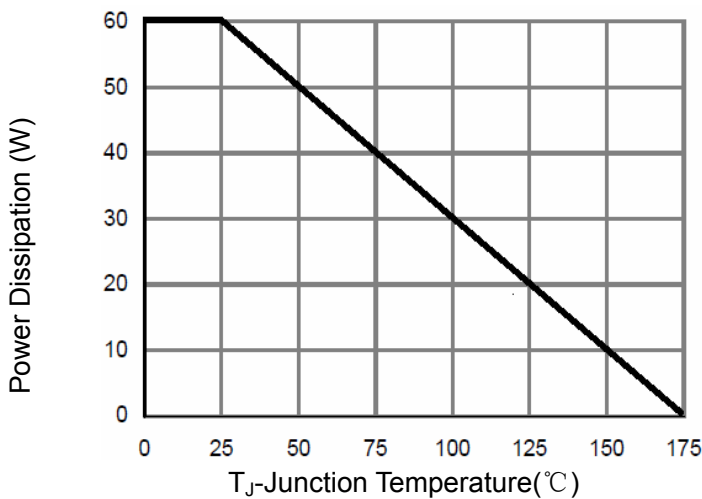


Figure 9 Power De-rating

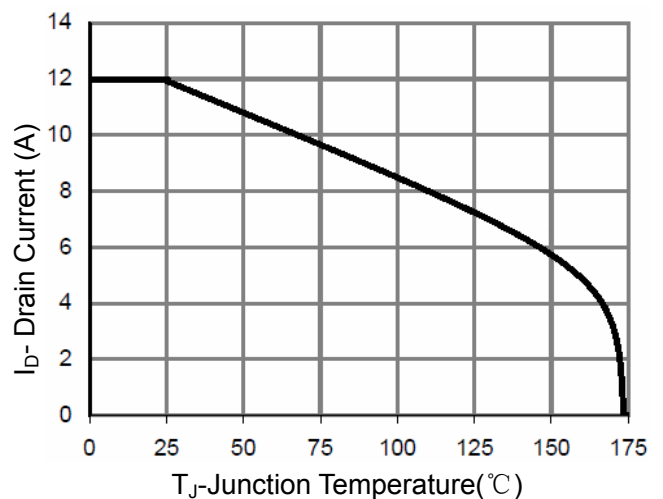


Figure 10 ID Current De-rating

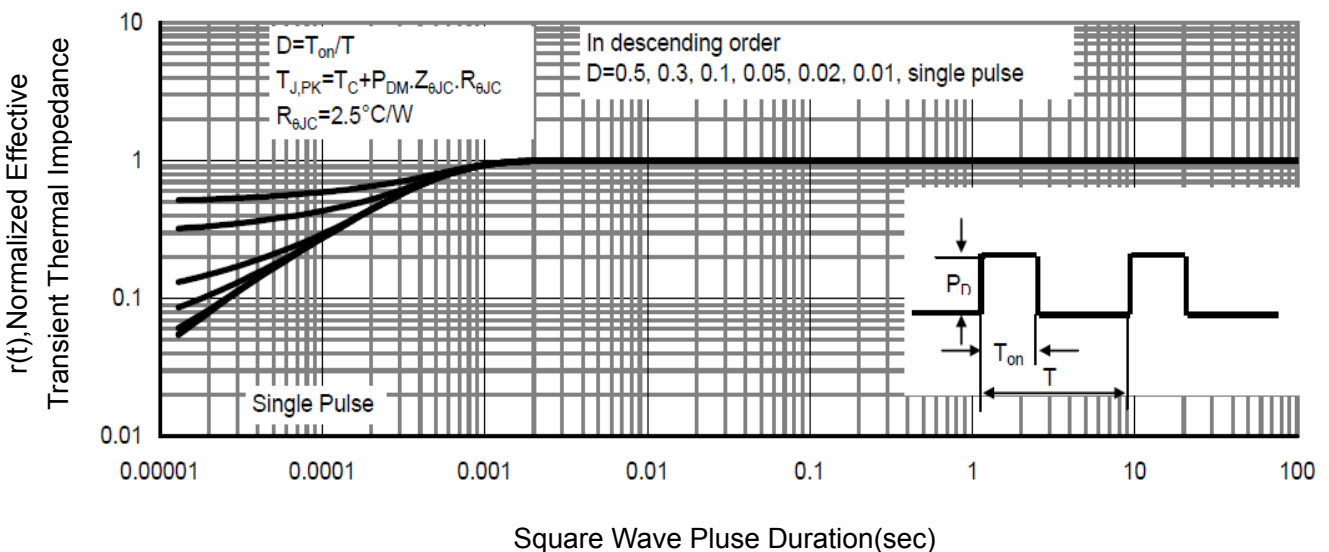
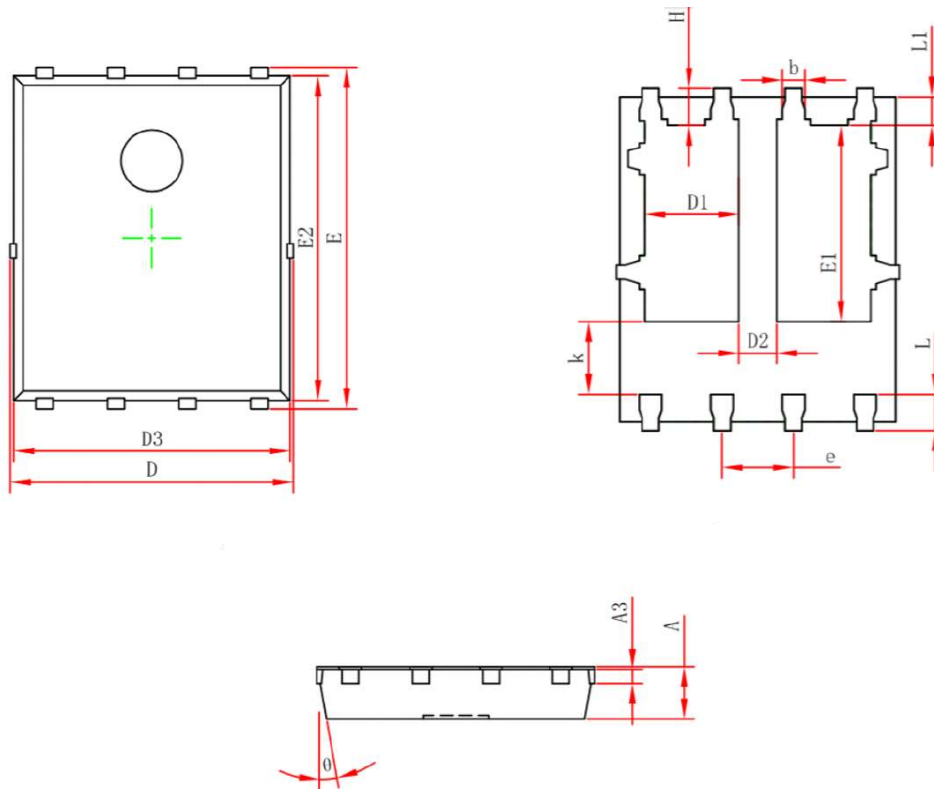


Figure 11 Normalized Maximum Transient Thermal Impedance

Package Mechanical Data:DFN5x6-8L



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 0.900 | 1.000 | 0.035 | 0.039 |
| A3 | 0.154REF. | | 0.006REF. | |
| D | 4.944 | 5.096 | 0.195 | 0.201 |
| E | 5.974 | 6.126 | 0.235 | 0.241 |
| D1 | 1.470 | 1.870 | 0.058 | 0.074 |
| D2 | 0.470 | 0.870 | 0.019 | 0.034 |
| E1 | 3.375 | 3.575 | 0.133 | 0.141 |
| D3 | 4.824 | 4.976 | 0.190 | 0.196 |
| E2 | 5.674 | 5.826 | 0.223 | 0.229 |
| k | 1.190 | 1.390 | 0.047 | 0.055 |
| b | 0.350 | 0.450 | 0.014 | 0.018 |
| e | 1.270TYP. | | 0.050TYP. | |
| L | 0.559 | 0.711 | 0.022 | 0.028 |
| L1 | 0.424 | 0.576 | 0.017 | 0.023 |
| H | 0.574 | 0.726 | 0.023 | 0.029 |
| θ | 10° | 12° | 10° | 12° |